SCOPE: +5V-Powered Multi-Channel RS-232 Drivers/Receivers

Device Type	Generic Number MAX232M(x)/883B	Pkg Code J16 & L20	n			
02	MAX230MJP/883B	J20	o .			
03	MAX231MJD/883B	J14				
04	MAX234MJE/883B	J16				
05	MAX236MRG/883B	R24				
06	MAX237MRG/883B	R24				
07	MAX238MRG/883B	R24				
08	MAX239MRG/883B	R24				
Case Outline(s	s). The case outlines shall be	designated in	Mil-Std-1835 and	as follows:		
Outline Le	tter Mil-Std-1835	<u>Ca</u>	se Outline P	ackage Co	<u>de</u>	
JD	GDIP1-T14 or CDIP2-		LEAD CERDIP	J14		
JE	GDIP1-T16 or CDIP2-		LEAD CERDIP	J16		
JP	GDIP1-T20 or CDIP2-		LEAD CERDIP	J20		
RG	GDIP1-T24 or CDIP2-		LEAD CERDIP	R24		
LP	CQCC1-N20	20	Leadless Chip Car	rier L20		
Absolute Maxin	mum Ratings		0.7	2V to +6V		
Input Voltage		••••••		V 10 11 V		
			0.3V to (V	$(_{CC} + 0.3V)$		
R _{IN}				±30V		
Output Volta	iges:					
	Duration, T _{OUT}					
-	re (soldering, 10 seconds)					
Storage Temper	ature			-65°C to +1	160°C	
	ver Dissipation					
	(derate 9.1mW/ $^{\circ}$ C above +70 $^{\circ}$					
•	(derate $10 \text{mW}/^{\circ}\text{C}$ above $+70^{\circ}\text{C}$					
•	(derate $11.1 \text{mW}/^{\circ}\text{C}$ above $+70$					
	(derate $12.5 \text{mW}/^{\circ}\text{C}$ above $+70 \text{c}$	*				
	ate $9.1 \text{mW/}^{\circ}\text{C}$ above $+70 ^{\circ}\text{C}$).					
	rature T_J	•••••		+150		
	DIP			55°C/X	i.	
	DIP					
	DIP					
•	DIP					
-						
	ance, Junction to Ambient, Θ		•••••	20 C/ W	•	
	DIP			110°C/\	W	
_	DIP					
-	DIP					
•	DIP					
•						
20 pin Lee	••••••	• • • • • • • • • • • • • • • • • • • •	•••••	110 C/ W	•	
	Operating Conditions		£50~	1 10500		
-	ating Range (T _A)					
Supply Voltage	e Range		3	ov to 30V		
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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TABLE 1. ELECTRICAL TESTS:

		CONDITIONS $-55 \text{ °C} <= T_A <= +125 \text{ °C} \underline{1}/$	Group A Subgroup	Device	Limits	Limits	Units
TEST	Symbol	Unless otherwise specified	Subgroup	type	Min	Max	
Output Voltage Swing	V _{OUT}	All transmitter outputs loaded with $3k\Omega$ to Gnd	1,2,3	All	±5.0		V
				01		10	
V _{CC} Power-Supply Current		No load	1	02,04,05, 06,07		15	mA
				03,08		1	
				03		5	_
V+ Power-Supply Current		No load	1	08		15	mA
Shutdown Supply Current			1	02,05		10	μΑ
RS-232 TRANSMITTERS							
Input Logic Threshold	V _{IL}	T _{IN}		All		0.8	
Low		ĒN	1,2,3	05,08		0.8	V
		SHDN		02,05		0.8	
Input Logic Threshold	V _{IN}	T _{IN}		All	2.0		V
High		EN	1,2,3	05,08	2.4		
		SHDN		02,05	2.4		
Logic Pull-up/Current Low	I_{IL}	T _{IN} =0V	1,2,3	All		200	μΑ
	_			01		±25	
Output short circuit current	I_{OST}	V _{OUT} =0V, Sourcing current V _{OUT} =0V, Sinking current	1	02,03,04, 05,06,07, 08		±45	mA
Transmitter Output Resistance	R _{TOUT}	V _{CC} =V+=V-=0V, V _{OUT} =±2V	1,2,3	All	300		Ω
RS-232 RECEIVERS							
Receiver Input Voltage Operating Range			1,2,3	01,03,05, 06,07,08	-30	+30	V
RS-232 Input Threshold Low	V_{IL}	Normal Operation V _{CC} =5V	1 2,3	01,03,05, 06,07,08	0.8 0.4		V
RS-232 Input Threshold High	V_{IH}	Normal Operation V _{CC} =5V	1 2,3	01,03,05, 06,07,08		2.4 3.0	V
RS-232 Input Hysteresis	V_{TH}	V _{CC} =5V	1,2,3	01,03,05, 06,07,08	0.2	1.0	V
RS-232 Input Resistance	R _{IN}	V _{CC} =5V	1,2,3	01,03,05, 06,07,08	3.0	7.0	kΩ

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TEST	Symbol	CONDITIONS $-55 \text{ °C} <= T_A <= +125 \text{ °C} \underline{1}/$ Unless otherwise specified	Group A Subgroup	Device type	Limits Min	Limits Max	Units
TTL/CMOS Output	V _{OL}	I _{OUT} =3.2mA	1.2.2	01,03		0.4	17
Voltage Low		I _{OUT} =1.6mA	1,2,3	05,06 07,08		0.4	V
TTL/CMOS Output Voltage High	V _{OH}	I _{OUT} =1.0mA	1,2,3	01,03,05, 06,07,08	3.5		V
TTL/CMOS Output Leakage Current		$0V \le R_{OUT} \le V_{CC}, \underline{\hspace{1cm}} EN = V_{CC}$	1,2,3	05,08		±10	μΑ
Receiver Output Enable Time		NOTE 2		05,08		400	ns
Receiver Output Disable Time		NOTE 2		05,08		250	ns
Propagation Delay		RS-232 IN to TTL/CMOS OUT, C _L =150pF	9,10,11	01,03,05, 06,07,08		10	μs
Transition Region Slew Rate	tSLEW	C_L =50pF to 2500pF, RL=3k Ω -7k Ω , VCC=5V measured from +3V to -3V or -3V to +3V	9	02,04,05, 06,07,08	3.0	30	V/µs
		13 7 10 -3 7 01 -3 7 10 13 7		01,03	1.5	30	ν/μο

NOTE 1: V_{CC} =+5V ±10% for MAX230, MAX232, MAX234, MAX236, MAX237 or MAX238. for dash 02, 01, 04, 05, 06, 07 respectively.

 $V_{CC}\!\!=\!\!+5V$ $\pm10\%,\,V+\!\!=\!\!9.0V$ to 13.2V for MAX231 and MAX239 or for dash 03 and 08 respectively. NOTE 2: Typical design limit.

TERMINAL CONNECTIONS FOR 01, 02, 03, 04, 05, 06, 07, 08

	02	03	01	01 LCC	04	05	06	07	08
1	T3 _{OUT}	C+	C1+	NC	$T1_{OUT}$	T3 _{OUT}	T3 _{OUT}	$T2_{OUT}$	R1 _{OUT}
2	T1 _{OUT}	C-	V+	C1+	$T2_{OUT}$	$T1_{OUT}$	$T1_{OUT}$	$T1_{OUT}$	$R1_{IN}$
3	T2 _{OUT}	V-	C1-	V+	T2 _{IN}	T2 _{OUT}	T2 _{OUT}	R2 _{IN}	GND
4	T2 _{IN}	T2 _{OUT}	C2+	C1-	$T1_{IN}$	$R1_{IN}$	$R1_{IN}$	R2 _{OUT}	V_{CC}
5	$T1_{IN}$	R2 _{IN}	C2-	C2+	GND	R1 _{OUT}	R1 _{OUT}	$T1_{IN}$	V+
6	GND	R2 _{OUT}	V-	NC	V_{CC}	$T2_{IN}$	$T2_{IN}$	R1 _{OUT}	C+
7	V _{CC}	T2 _{IN}	T2 _{OUT}	C2-	C1+	$T1_{IN}$	$T1_{IN}$	$R1_{IN}$	C-
8	C1+	$T1_{IN}$	R2 _{IN}	V-	V+	GND	GND	GND	V-
9	V+	R1 _{OUT}	R2 _{OUT}	T2 _{OUT}	C1-	V_{CC}	V_{CC}	V_{CC}	R5 _{IN}
10	C1-	$R1_{IN}$	$T2_{IN}$	R2 _{IN}	C2+	C1+	C1+	C1+	R5 _{OUT}
11	C2+	T1 _{OUT}	$T1_{IN}$	NC	C2-	V+	V+	V+	R4 _{OUT}
12	C2-	GND	R1 _{OUT}	R2 _{OUT}	V-	C1-	C1-	C1-	R4 _{IN}
13	V-	V_{CC}	R1 _{IN}	T2 _{IN}	$T3_{IN}$	C2+	C2+	C2+	T3 _{OUT}
14	$T3_{IN}$	V+	T1 _{OUT}	$T1_{IN}$	$T4_{IN}$	C2-	C2-	C2-	
									EN
15	T4 _{IN}		GND	R1 _{OUT}	T4 _{OUT}	V-	V-	V-	NC
16	T5 _{OUT}		V_{CC}	NC	T3 _{OUT}	R3 _{IN}	R3 _{IN}	R4 _{IN}	$T3_{IN}$
17	SHDN			$R1_{IN}$		R3 _{OUT}	R3 _{OUT}	R4 _{OUT}	R3 _{OUT}
18	NC			$T1_{OUT}$		$T3_{IN}$	T3 _{IN}	$T2_{IN}$	R3 _{IN}
19	$T5_{IN}$			GND		T4 _{IN}	T4 _{IN}	$T3_{IN}$	T1 _{OUT}
20	T4 _{OUT}			V_{CC}			$T5_{OUT}$	T4 _{OUT}	T2 _{OUT}
						EN			
21						SHDN	T5 _{IN}	T4 _{IN}	R2 _{IN}
22						R2 _{OUT}	R2 _{OUT}	R3 _{OUT}	R2 _{OUT}
23						R2 _{IN}	R2 _{IN}	$R3_{IN}$	T2 _{IN}
24						T4 _{OUT}	T4 _{OUT}	T3 _{OUT}	$T1_{IN}$

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	Package	ORDERING INFORMATION:	SMD Number
01	16 pin CERDIP	MAX232MJE/883B	5962-8987701EA
01	20 pin LCC	MAX232MLP/883B	5962-89877012C
02	20 pin CERDIP	MAX230MJP/883B	5962-8987702RA
03	14 pin CERDIP	MAX231MJD/883B	5962-8987703CA
04	16 pin CERDIP	MAX234MJE/883B	5962-8987704EA
05	24 pin CERDIP	MAX236MRG/883B	5962-8987705JA
06	24 pin CERDIP	MAX237MRG/883B	5962-8987706JA
07	24 pin CERDIP	MAX238MRG/883B	5962-8987707JA
08	24 pin CERDIP	MAX239MRG/883B	5962-8987708JA

QUALITY ASSURANCE

Sampling and inspection procedures shall be in accordance with MIL-Prf-38535, Appendix A as specified in Mil-Std-883.

Screening shall be in accordance with Method 5004 of Mil-Std-883. Burn-in test Method 1015:

- 1. Test Condition, A, B, C, or D.
- 2. TA = +125°C minimum.
- 3. Interim and final electrical test requirements shall be specified in Table 2.

Quality conformance inspection shall be in accordance with Method 5005 of Mil-Std-883, including Groups A, B, C, and D inspection.

Group A inspection:

- 1. Tests as specified in Table 2.
- 2. Selected subgroups in Table 1, Method 5005 of Mil-Std-883 shall be omitted.

Group C and D inspections:

- a. End-point electrical parameters shall be specified in Table 1.
- b. Steady-state life test, Method 1005 of Mil-Std-883:
 - 1. Test condition A, B, C, D.
 - 2. TA = +125°C, minimum.
 - 3. Test duration, 1000 hours, except as permitted by Method 1005 of Mil-Std-883.

TABLE 2. ELECTRICAL TEST REQUIREMENTS

Mil-Std-883 Test Requirements	Subgroups per Method 5005, Table 1
Interim Electric Parameters Method 5004	1
Final Electrical Parameters Method 5005	1*, 2, 3, 9, 10, 11
Group A Test Requirements Method 5005	1, 2, 3, 9, 10, 11
Group C and D End-Point Electrical Parameters Method 5005	1

^{*} PDA applies to Subgroup 1 only.

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